



Basic Infrastructure for Hi-Tech Park, Sylhet (Sylhet Electronics City) 1st Revised Project
Bangladesh Hi-Tech Park, Authority
Information & Communication Division
ICT Tower (Level-10), Agargaon, Dhaka-1207
<http://www.bhtpa.gov.bd/>

Memo No: 56.02.0000.00.9.01.125.18- 1166

Date: 26/05/2019

Invitation for e-Tender

1.	Division	Information & Communication Technology Division
2.	Organization	Basic Infrastructure for Hi-Tech Park, Sylhet (Sylhet Electronics City) 1st Revised Project.
3.	Procurement Method	Open Tendering Method (National)
4.	Tender Package No.	SHTP-WD9
5.	Budget and Source of Funds	GoB
6.	Invitation Ref No & Date	56.02.0000.009.01.144.19-1164 Date: 22/05/2019
7.	Tender ID (from e-GP portal)	322210
8.	Tender Closing Date Time	24-june-2019 at 12:00 PM
9.	Name of work	Construction of External Boundary Wall For Hi-Tech Park Sylhet (Sylhet Electronics City) at Companigonj Sylhet.
10.	This is an Online Tender, where only e-Tender will be accepted in e-GP portal and no Offline & hard copy will be accepted. To submit e-Tender register on e-GP System (http://www.bhtpa.gov.bd) is required. Further information & guidelines are available in National e-GP System portal and from e-GP help desk (helpdesh@eprocure.gov.bd) contact no-028181356	

Project Director